SMP1302 Series: Switch and Attenuator Plastic-Packaged PIN Diodes

Applications
- TV distribution and cellular base stations
- High volume switch and attenuators

Features
- Designed for base station and handset applications
- Low-distortion design
- Available in tape and reel packaging
- Packages rated MSL1 @ 260 °C per JEDEC J-STD-020

Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to Skyworks Definition of Green™, document number SQ04–0074.

Description
The SMP1302 series of plastic-packaged, surface-mountable, low-capacitance (0.3 pF) silicon PIN diodes is designed for high-volume switch and attenuator applications from 10 MHz to beyond 10 GHz.

These diodes are designed for use in low-distortion TEE attenuators with low drive current (maximum resistance at 1 mA is 10 Ω) commonly used in TV distribution and cellular base station applications. The nominal 50 μm I region width, combined with a maximum resistance of 3 Ω at 10 mA, makes these diodes useful in large signal switch applications.

The SMP1302 series provides single, dual, and quad diodes in a selection of plastic packages including SOT-23, SOD-323, SC-79, SC-88, and a small footprint SOD-882.

Table 1 describes the various packages and marking of the SMP1302 series.
Table 1. SMP1302 Series Packaging and Marking

<table>
<thead>
<tr>
<th></th>
<th>Common Anode</th>
<th>Single</th>
<th>Quad Common Cathode</th>
<th>Single</th>
</tr>
</thead>
<tbody>
<tr>
<td>SOT-23</td>
<td>SOD-323</td>
<td>SC-79</td>
<td>SC-88</td>
<td>SOD-882</td>
</tr>
<tr>
<td>Green™</td>
<td>Green™</td>
<td>Green™</td>
<td>Green™</td>
<td>Green™</td>
</tr>
<tr>
<td>SMP1302-003LF</td>
<td>SMP1302-011LF</td>
<td>SMP1302-078LF</td>
<td>SMP1302-040LF</td>
<td></td>
</tr>
<tr>
<td>Marking: RF9</td>
<td>Marking: RF</td>
<td>Marking: XIX</td>
<td>Marking: W</td>
<td></td>
</tr>
</tbody>
</table>

LS = 1.5 nH L3 = 1.5 nH L2 = 0.7 nH L1 = 1.4 nH L0 = 0.45 nH

SMP1302-078LF Pinout

Table 2 provides the signal pin assignments for the 6-pin SC-88 quad common cathode package.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SMP1302 series are provided in Table 3. Electrical specifications are provided in Table 4. Resistance versus temperature measurements are provided in Table 5.

Typical performance characteristics of the SMP1302 series are illustrated in Figures 1 to 4. Package dimensions are shown in Figures 5 to 13 (odd numbers), and tape and reel dimensions are provided in Figures 6 to 14 (even numbers).

Table 2. SMP1302-078LF Pin Signals

<table>
<thead>
<tr>
<th>Pin</th>
<th>Name</th>
<th>Pin</th>
<th>Name</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Anode 1</td>
<td>4</td>
<td>Anode 3</td>
</tr>
<tr>
<td>2</td>
<td>Common cathode</td>
<td>5</td>
<td>Common cathode</td>
</tr>
<tr>
<td>3</td>
<td>Anode 2</td>
<td>6</td>
<td>Anode 4</td>
</tr>
</tbody>
</table>
Table 3. SMP1302 Series Absolute Maximum Ratings

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Minimum</th>
<th>Maximum</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Reverse voltage</td>
<td>( V_R )</td>
<td>200</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Power dissipation @ 25 °C lead temperature</td>
<td>( P_{DS} )</td>
<td>250</td>
<td></td>
<td>mW</td>
</tr>
<tr>
<td>Storage temperature</td>
<td>( T_{STG} )</td>
<td>-65</td>
<td>+150</td>
<td>°C</td>
</tr>
<tr>
<td>Operating temperature</td>
<td>( T_A )</td>
<td>-65</td>
<td>+150</td>
<td>°C</td>
</tr>
<tr>
<td>Electrostatic discharge:</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Human Body Model (HBM), Class 1C</td>
<td>ESD</td>
<td>1000</td>
<td>2000</td>
<td>V</td>
</tr>
</tbody>
</table>

Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.

Table 4. SMP1302 Series Electrical Specifications

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Test Condition</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Reverse current</td>
<td>( I_R )</td>
<td>( V_R = 200 \mathrm{V} )</td>
<td>10</td>
<td></td>
<td></td>
<td>( \mu \mathrm{A} )</td>
</tr>
<tr>
<td>Capacitance</td>
<td>( C_T )</td>
<td>( f = 1 \mathrm{MHz}, V = 30 \mathrm{V} )</td>
<td>0.3</td>
<td></td>
<td></td>
<td>( \mathrm{pF} )</td>
</tr>
<tr>
<td>Resistance</td>
<td>( R_S )</td>
<td>( f = 100 \mathrm{MHz} )</td>
<td></td>
<td>15</td>
<td></td>
<td>( \Omega )</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( I = 1 \mathrm{mA} )</td>
<td></td>
<td>20</td>
<td></td>
<td>( \Omega )</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( I = 10 \mathrm{mA} )</td>
<td></td>
<td>3</td>
<td></td>
<td>( \Omega )</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( I = 100 \mathrm{mA} )</td>
<td></td>
<td>1.5</td>
<td></td>
<td>( \Omega )</td>
</tr>
<tr>
<td>Forward voltage</td>
<td>( V_F )</td>
<td>( I_F = 10 \mathrm{mA} )</td>
<td>0.8</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Carrier lifetime</td>
<td>( T_I )</td>
<td>( I = 10 \mathrm{mA} )</td>
<td>0.7</td>
<td></td>
<td></td>
<td>( \mu \mathrm{s} )</td>
</tr>
<tr>
<td>I region width</td>
<td></td>
<td></td>
<td>50</td>
<td></td>
<td></td>
<td>( \mu \mathrm{m} )</td>
</tr>
</tbody>
</table>

Performance is guaranteed only under the conditions listed in this table.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SMP1302 series is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering.

For additional information, refer to the Skyworks Application Note, Solder Reflow Information, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.
Table 5. Resistance vs Temperature @ 100 MHz

<table>
<thead>
<tr>
<th>If (mA)</th>
<th>Rs @ -55 °C (Ω)</th>
<th>Rs @ -15 °C (Ω)</th>
<th>Rs @ +25 °C (Ω)</th>
<th>Rs @ +65 °C (Ω)</th>
<th>Rs @ +100 °C (Ω)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.02</td>
<td>599</td>
<td>653</td>
<td>692</td>
<td>715</td>
<td>722</td>
</tr>
<tr>
<td>0.10</td>
<td>123</td>
<td>135</td>
<td>143</td>
<td>154</td>
<td>161</td>
</tr>
<tr>
<td>0.3</td>
<td>42.2</td>
<td>46.6</td>
<td>49.7</td>
<td>54.3</td>
<td>56.8</td>
</tr>
<tr>
<td>1.0</td>
<td>13.5</td>
<td>15.0</td>
<td>16.2</td>
<td>17.9</td>
<td>18.8</td>
</tr>
<tr>
<td>10</td>
<td>2.0</td>
<td>2.3</td>
<td>2.6</td>
<td>2.9</td>
<td>3.0</td>
</tr>
<tr>
<td>20</td>
<td>1.34</td>
<td>1.50</td>
<td>1.70</td>
<td>2.00</td>
<td>2.00</td>
</tr>
<tr>
<td>100</td>
<td>0.60</td>
<td>0.74</td>
<td>1.00</td>
<td>1.10</td>
<td>1.10</td>
</tr>
</tbody>
</table>

Typical Performance Characteristics
(Ta = +25 °C, Unless Otherwise Noted)

Figure 1. Series Resistance vs Current @ 100 MHz

Figure 2. DC Characteristic

Figure 3. Capacitance vs Reverse Voltage

Figure 4. Conductance vs Frequency and Reverse Voltage
Figure 5. SC-79 Package Dimension Drawing

Figure 6. SC-79 Tape and Reel Dimensions

Notes:
1. Carrier tape: black conductive polycarbonate or polystyrene.
2. Cover tape material: transparent conductive PSA.
3. Cover tape size: 5.4 mm width.
4. ESD-surface resistivity is ≤1 x 10^8 Ohms/square per EIA, JEDEC TNR Specification.
5. All measurements are in millimeters.
Figure 7. SC-88 Package Dimension Drawing

Notes:
1. Carrier tape: black conductive polystyrene.
2. Cover tape material: transparent conductive HSA.
3. Cover tape size: 5.40 mm width.
4. Ten sprocket hole pitch cumulative tolerance ±0.20 mm.
5. All measurements are in millimeters.
6. Standard reel size is 7 inches. Standard reel quantity is 3000 pcs.

Figure 8. SC-88 Tape and Reel Dimensions
Figure 9. SOD-323 Package Dimension Drawing

Figure 10. SOD-323 Tape and Reel Dimensions

Notes:
1. Carrier tape: black conductive polystyrene.
2. Cover tape: transparent conductive PSA.
3. Cover tape size: 5.4 mm width.
4. 10 sprocket hole pitch cumulative tolerance: ±0.20 mm.
5. All measurements are in millimeters.
Dimensions are in inches (millimeters shown in parentheses)

Figure 11. SOT-23 Package Dimension Drawing

Notes:
1. Carrier tape: black conductive polycarbonate.
2. Cover tape material: transparent conductive PSA.
3. Cover tape size: 5.40 mm width.
4. Tolerance ±0.10 mm.
5. Ten sprocket hole pitch cumulative tolerance: ±0.2 mm.
6. All measurements are in millimeters.
7. Alternative carrier tape dimensions are:
   \[ \text{Ao} = 3.3 \]
   \[ \text{Bo} = 2.9 \]
   \[ \text{Ko} = 1.22 \]

Figure 12. SOT-23 Tape and Reel Dimensions
Notes:
1. All measurements are in millimeters.
3. These packages are used principally for discrete devices.
4. This dimension includes stand-off height and package body thickness, but does not include attached features, e.g., external heatsink or chip capacitors. An integral heatslug is not considered an attached feature.
5. This dimension is primarily terminal plating, but does not include small metal protrusion.

Figure 13. SOD-882 Package Dimension Drawing

Notes:
1. Carrier tape: black conductive polycarbonate.
2. Cover tape: transparent conductive material.
3. Cover tape size: 5.4 mm width.
4. ESD surface resistivity is ≥1 x 10^4 ~ ≤ 1 x 10^8 Ohms/square.
5. All dimensions are in millimeters.

Figure 14. SOD-882 Tape and Reel Dimensions